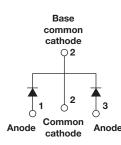
# VS-HFA16TA60CSPbF

Vishay Semiconductors

## HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 2 x 8 A



www.vishay.com



PRODUCT SUMMARY								
Package	TO-263AB (D <sup>2</sup> PAK)							
I <sub>F(AV)</sub>	2 x 8 A							
V <sub>R</sub>	600 V							
V <sub>F</sub> at I <sub>F</sub>	1.7 V							
t <sub>rr</sub> (typ.)	18 ns							
T <sub>J</sub> max.	150 °C							
Diode variation	Common cathode							

## FEATURES

- Ultrafast and ultrasoft recovery
- Very low I<sub>RRM</sub> and Q<sub>rr</sub>
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

### DESCRIPTION

VS-HFA16TA60CS is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 8 A per leg continuous current, the VS-HFA16TA60CS is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I<sub>RRM</sub>) and does not exhibit any tendency to "snap-off" during the t<sub>b</sub> portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA16TA60CS is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Cathode to anode voltage	V <sub>R</sub>		600	V						
Maximum continuous forward currentper leg	I_	T <sub>C</sub> = 100 °C	8							
per device	IF	1 <sub>C</sub> = 100 C	16	А						
Single pulse forward current	I <sub>FSM</sub>		60	~						
Maximum repetitive forward current	I <sub>FRM</sub>		24							
Maximum power dissipation	PD	T <sub>C</sub> = 25 °C	36	W						
	гD	T <sub>C</sub> = 100 °C	14	vv						
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C						

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<b>ELECTRICAL SPECIFICATIONS PER LEG</b> ( $T_J$ = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS		
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA	600	-	-				
Maximum forward voltage		I <sub>F</sub> = 8.0 A		-	1.4	1.7			
	V <sub>FM</sub>	I <sub>F</sub> = 16 A	See fig. 1	-	1.7	2.1			
		$I_F = 8.0 \text{ A},  \text{T}_\text{J} = 125 \ ^\circ\text{C}$		-	1.4	1.7			
Maximum reverse		$V_R = V_R$ rated	0	-	0.3	5.0			
leakage current	I <sub>RM</sub>	$T_J$ = 125 °C, $V_R$ = 0.8 x $V_R$ rated	See fig. 2	-	100	500	μA		
Junction capacitance	CT	V <sub>R</sub> = 200 V See fig. 3		-	10	25	pF		
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from p	ackage body	-	8.0	-	nH		

<b>DYNAMIC RECOVERY CHARACTERISTICS PER LEG</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
Reverse recovery time See fig. 5, 6 and 16	t <sub>rr</sub>	I <sub>F</sub> = 1.0 A, dI <sub>F</sub> /dt = 200	A/ $\mu$ s, V <sub>R</sub> = 30 V	-	18	-			
	t <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	37	55	ns		
	t <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	55	90			
Peak recovery current See fig. 7 and 8	I <sub>RRM1</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 8.0 A	-	3.5	5.0	A		
	I <sub>RRM2</sub>	T <sub>J</sub> = 125 °C		-	4.5	8.0			
Reverse recovery charge See fig. 9 and 10	Q <sub>rr1</sub>	T <sub>J</sub> = 25 °C	dl <sub>F</sub> /dt = 200 A/µs	-	65	138			
	Q <sub>rr2</sub>	T <sub>J</sub> = 125 °C	V <sub>R</sub> = 200 V	-	124	360	no		
Peak rate of fall of recovery current during t <sub>b</sub>	dl <sub>(rec)M</sub> /dt1	T <sub>J</sub> = 25 °C		-	240	-	A∕µs		
See fig. 11 & 12	dl <sub>(rec)M</sub> /dt2	T <sub>J</sub> = 125 °C		-	210	-	A/µs		

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Lead temperature	T <sub>lead</sub>	0.063" from case (1.6 mm) for 10 s	-	-	300	°C			
Junction to case, single leg conducting	P		-	-	3.5				
Junction to case, both legs conducting	— R <sub>thJC</sub>		-	-	1.75	K/W			
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	80				
Weight			-	2	-	g			
weight			-	0.07	-	oz.			
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)			
Marking device		Case style D <sup>2</sup> PAK		HFA16TA60CS					



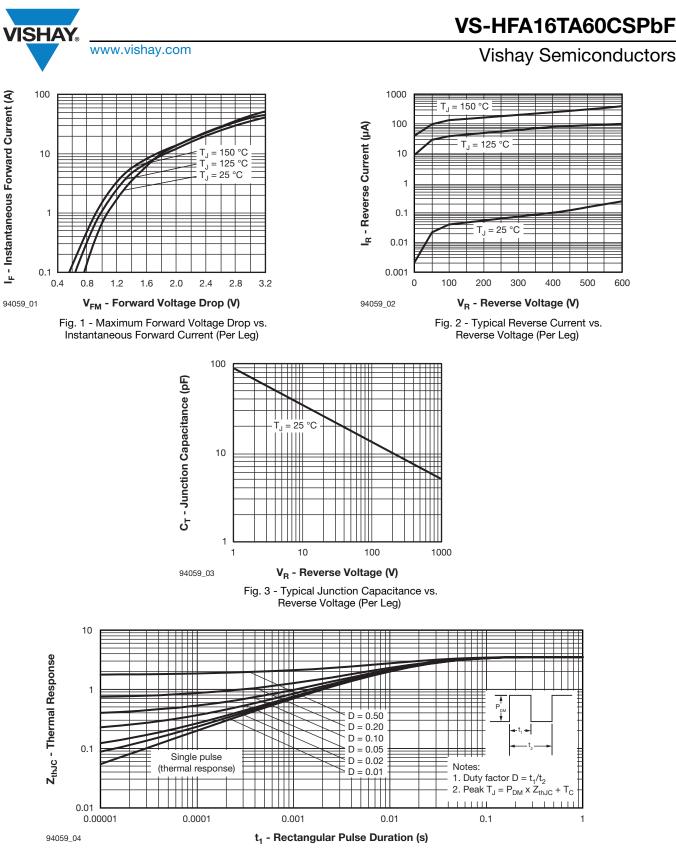


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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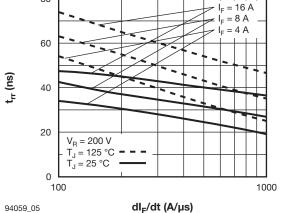


Fig. 5 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt (Per Leg)

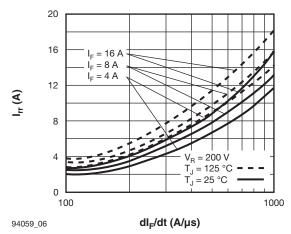


Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt (Per Leg)

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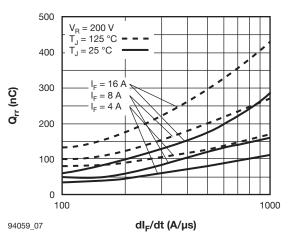


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt (Per Leg)

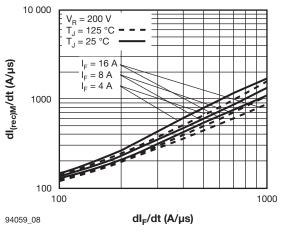


Fig. 8 - Typical dI<sub>(rec)M</sub>/dt vs. dI<sub>F</sub>/dt (Per Leg)





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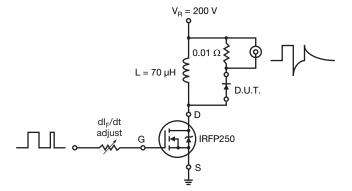
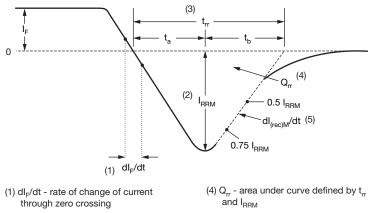


Fig. 9 - Reverse Recovery Parameter Test Circuit



(2) I<sub>RRM</sub> - peak reverse recovery current

(3)  $t_{\rm rr}$  - reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75  $I_{\text{RRM}}$  and 0.50  $I_{\text{RRM}}$  extrapolated to zero current.

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

- (5)  $dI_{(rec)M}/dt$  peak rate of change of current during  $t_b$  portion of  $t_{rr}$
- Fig. 10 Reverse Recovery Waveform and Definitions

### **ORDERING INFORMATION TABLE**

Device code	VS-	HF	Α	16	ТА	60	С	S	TRL	PbF		
		2	3	4	5	6	7	8	9	10		
	1	Vishay Semiconductors product										
	4	<ul> <li>Current rating (16 = 16 A)</li> </ul>										
	5	- Package outline (TA = TO-220, 3 leads)										
	6	- Voltage rating (60 = 600 V)										
	7	- Circuit configuration (C = Common cathode)										
	8	- S = D <sup>2</sup> PAK										
	9	9 - • None = Tube										
	<ul> <li>TRL = Tape and reel (left oriented)</li> </ul>											
	• TRR = Tape and reel (right oriented)											
	10	- • Pl	oF = Lea	ad (Pb)-	free							
		• P	= Lead	(Pb)-fre	e (for D	<sup>2</sup> PAK T	RR and	TRL)				

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95046						
Part marking information	www.vishay.com/doc?95054						
Packaging information	www.vishay.com/doc?95032						

ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-HFA16TA60CSPBF	50	1000	Antistatic plastic tube							
VS-HFA16TA60CSTRRP	800	800	13" diameter reel							
VS-HFA16TA60CSTRLP	800	800	13" diameter reel							

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## **Outline Dimensions**

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D<sup>2</sup>PAK



Conforms to JEDEC outline D<sup>2</sup>PAK (SMD-220) в Pad layout (2)(3)A 11.00 MIN.-(E) F (0.43)ŧ (3) L1 4 ( |(0.38)<sup>MIN.</sup> (D1) (3) Detail A D 17.90 (0.70) Н 15.00 (0.625) (2) З 0.15)<sup>0.01</sup> Ľ L2 Ĥ ţ В В 2.32 MIN. (0.08) 2.64 (0.103) 2.41 (0.096) (3)Ċ 2 x b2 С View A - A 2 x h // ± 0.004 M B ⊕ 0.010 M A M B Base Plating (4) Metal 2 x e Н b1, b3 Gauge plane c1 (4) (c) В 0° to 8° ŧ. Seating Lead assignments plane L3 A1 Lead tip (b, b2) Diodes Section B - B and C - C 1. - Anode (two die)/open (one die) Scale: None 2., 4. - Cathode Detail "A" 3. - Anode

Rotated 90 °CW Scale: 8:1

SYMBOL	MILLIMETERS		INCHES		NOTES		IES		SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		
А	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3		
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3		
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3		
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC			
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625			
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110			
с	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3		
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070			
c2	1.14	1.65	0.045	0.065			L3 0.25 BSC 0.010		BSC					
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208			

### Notes

 $^{(1)}\,$  Dimensioning and tolerancing per ASME Y14.5 M-1994  $\,$ 

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

<sup>(3)</sup> Thermal pad contour optional within dimension E, L1, D1 and E1

<sup>(4)</sup> Dimension b1 and c1 apply to base metal only

<sup>(5)</sup> Datum A and B to be determined at datum plane H

<sup>(6)</sup> Controlling dimension: inch

<sup>(7)</sup> Outline conforms to JEDEC outline TO-263AB

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## **DIMENSIONS** in millimeters and inches



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